

# TMT1906P / TMB1906B N-CHANNEL POWER MOSFET

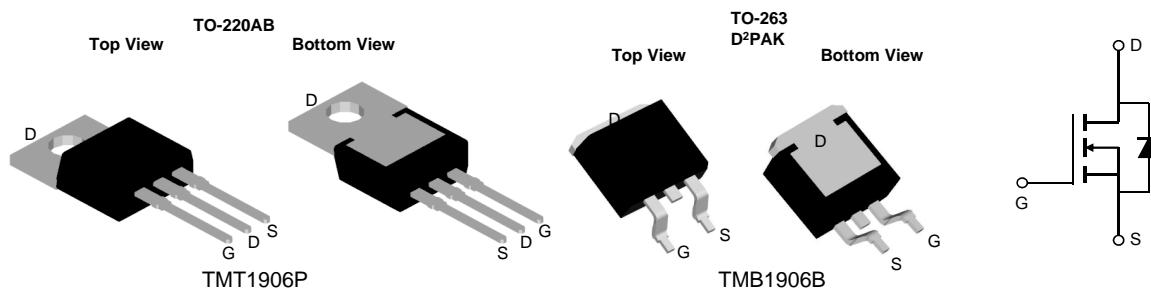
## General Description

- Power Management for Inverter Systems.

## Product Summary

- 60V / 120A,  
 $R_{DS(ON)} = 6.0\text{ m}\Omega$  (typ.) @  $V_{GS} = 10\text{V}$
- Avalanche Rated
- Reliable and Rugged
- Lead Free and Green Devices Available  
(RoHS Compliant)

100% UIS Tested  
100%  $R_g$  Tested



## Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
<b>Common Ratings</b> ( $T_c = 25^\circ\text{C}$ Unless Otherwise Noted)			
$V_{DSS}$	Drain-Source Voltage	60	V
$V_{GSS}$	Gate-Source Voltage	$\pm 25$	
$T_J$	Maximum Junction Temperature	175	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
$I_S$	Diode Continuous Forward Current	$T_c = 25^\circ\text{C}$	120
<b>Mounted on Large Heat Sink</b>			
$I_{DM}$	Pulsed Drain Current *	$T_c = 25^\circ\text{C}$	380**
$I_D$	Continuous Drain Current	$T_c = 25^\circ\text{C}$	120
		$T_c = 100^\circ\text{C}$	80
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ\text{C}$	188
		$T_c = 100^\circ\text{C}$	94
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.8	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62.5	
<b>Avalanche Ratings</b>			
$E_{AS}$	Avalanche Energy, Single Pulsed	$L = 0.5\text{mH}$	600***
			mJ

Note : \* Repetitive rating ; pulse width limited by junction temperature

\*\* Drain current is limited by junction temperature

\*\*\*  $VD = 48\text{V}$

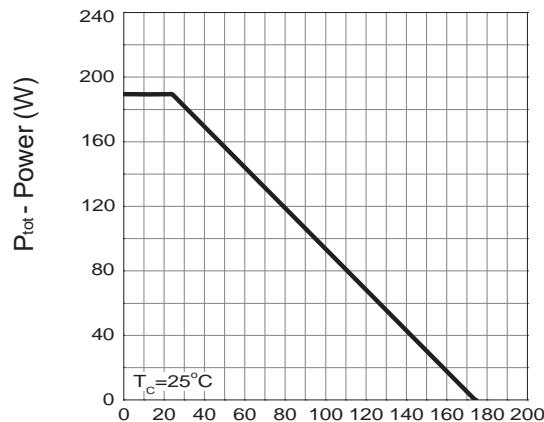
## Electrical Characteristics (T<sub>C</sub> = 25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	1906			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA	60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	-	-	1	μA
		T <sub>J</sub> =85°C	-	-	10	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250μA	2	3	4	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±25V, V <sub>DS</sub> =0V	-	-	±100	nA
R <sub>DS(ON)</sub> <sup>*</sup>	Drain-Source On-state Resistance	V <sub>GS</sub> =10V, I <sub>DS</sub> =60A	-	6.0	7.5	mΩ
<b>Diode Characteristics</b>						
V <sub>SD</sub> <sup>*</sup>	Diode Forward Voltage	I <sub>SD</sub> =60A, V <sub>GS</sub> =0V	-	0.8	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>SD</sub> =60A, dI <sub>SD</sub> /dt=100A/μs	-	50	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	95	-	nC
<b>Dynamic Characteristics</b>						
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz	-	1.0	-	Ω
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, Frequency=1.0MHz	-	4577	-	pF
C <sub>oss</sub>	Output Capacitance		-	876	-	
C <sub>rss</sub>	Reverse Transfer Capacitance		-	276	-	
t <sub>d(ON)</sub>	Turn-on Delay Time	V <sub>DD</sub> =30V, R <sub>G</sub> = 6 Ω, I <sub>DS</sub> =60A, V <sub>GS</sub> =10V,	-	13	26	ns
T <sub>r</sub>	Turn-on Rise Time		-	11	20	
t <sub>d(OFF)</sub>	Turn-off Delay Time		-	40	66	
T <sub>f</sub>	Turn-off Fall Time		-	60	95	
<b>Gate Charge Characteristics<sup>b</sup></b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V, I <sub>DS</sub> =60A	-	96	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	21	-	
Q <sub>gd</sub>	Gate-Drain Charge		-	23	-	

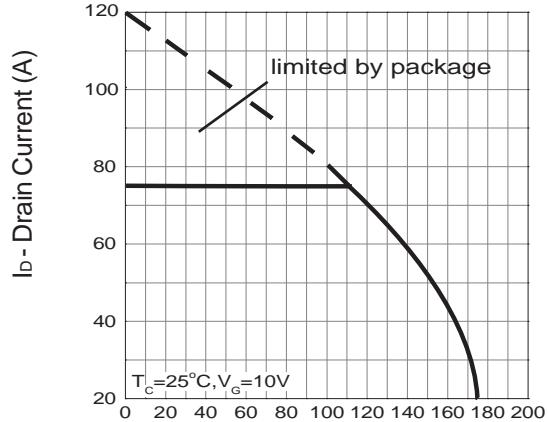
Note \* : Pulse test ; pulse width≤300μs, duty cycle≤2%.

## Typical Operating Characteristics

**Power Dissipation**

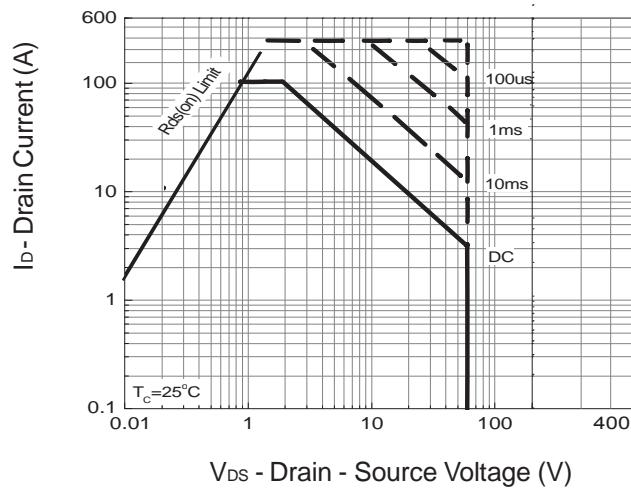


**Drain Current**



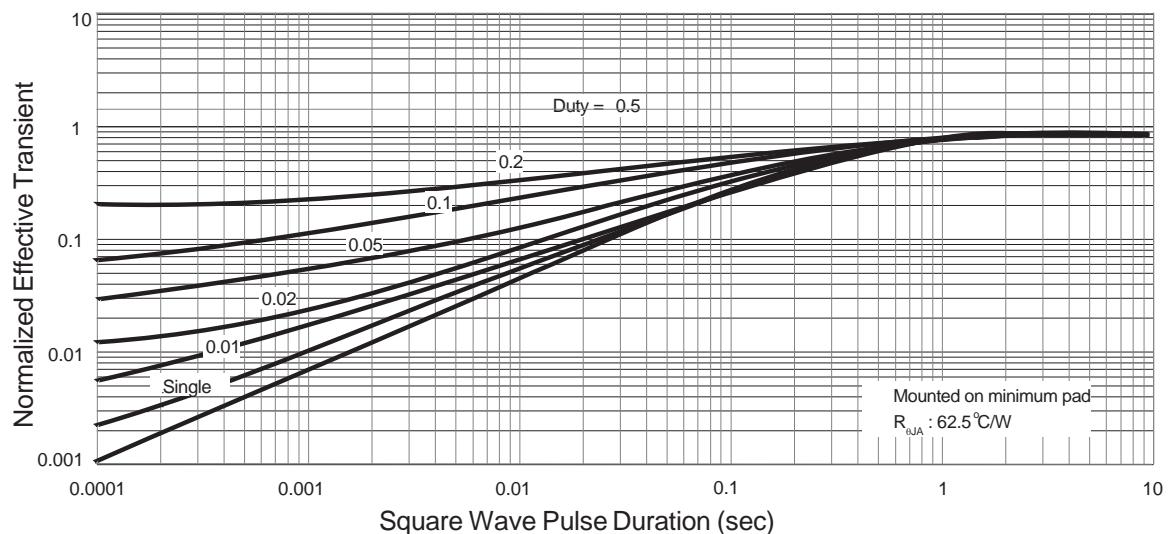
$T_c$ - Case Temperature (°C)

**Safe Operation Area**



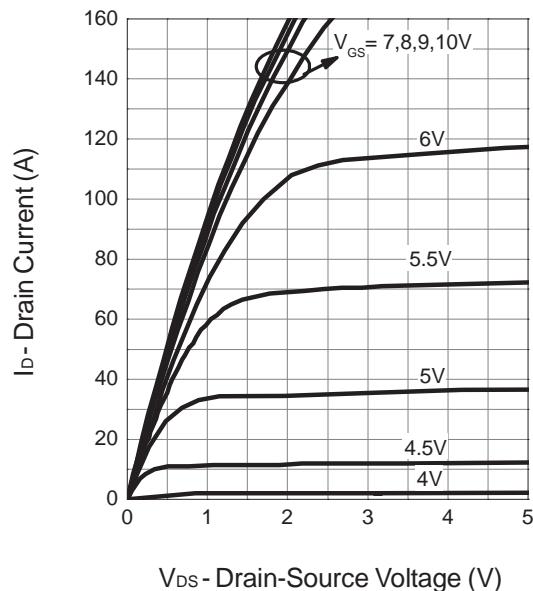
$V_{DS}$  - Drain - Source Voltage (V)

**Thermal Transient Impedance**

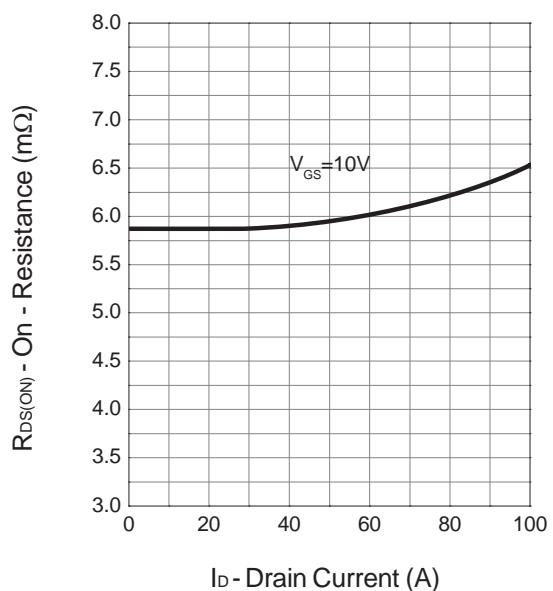


## Typical Operating Characteristics (Cont.)

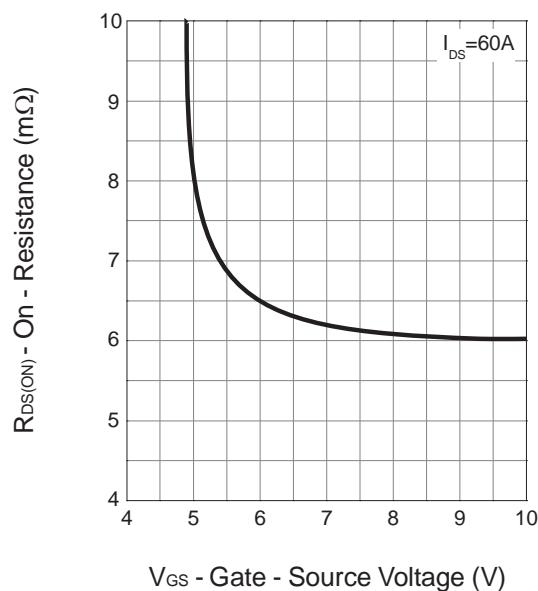
**Output Characteristics**



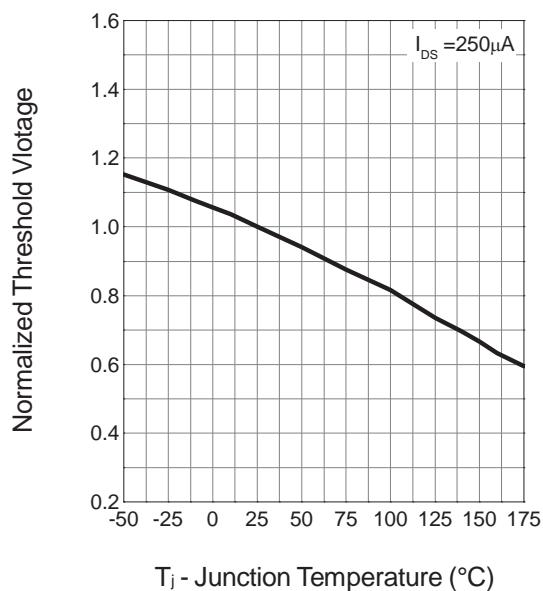
**Drain-Source On Resistance**



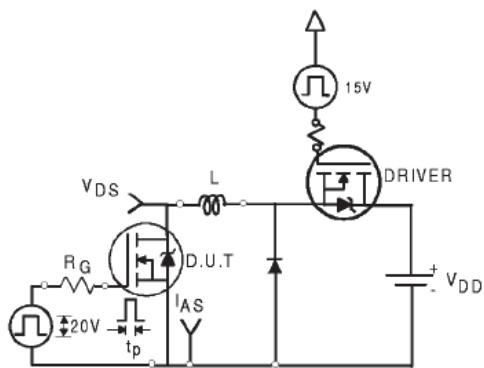
**Drain-Source On Resistance**



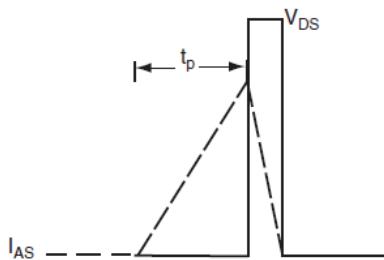
**Gate Threshold Voltage**



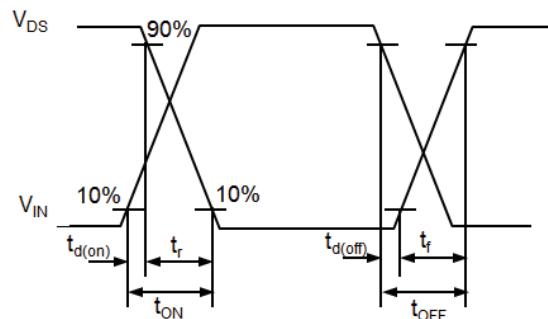
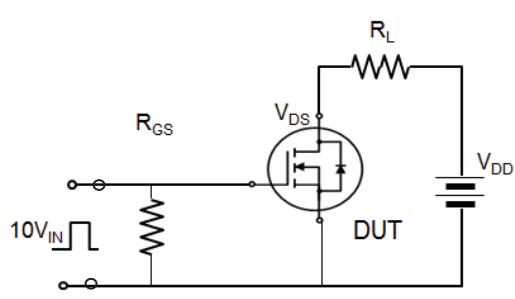
## Avalanche Test Circuit



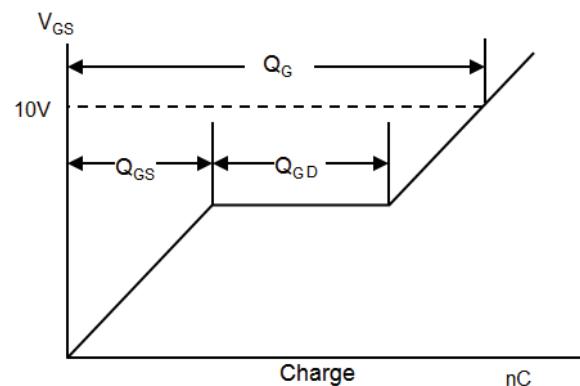
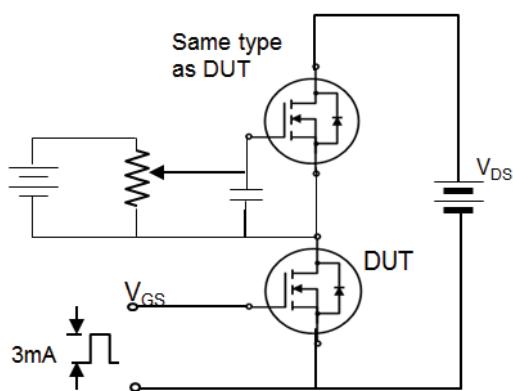
$$E_{AS} = \frac{1}{2} L I_{AS}^2$$



## Switching Time Test Circuit

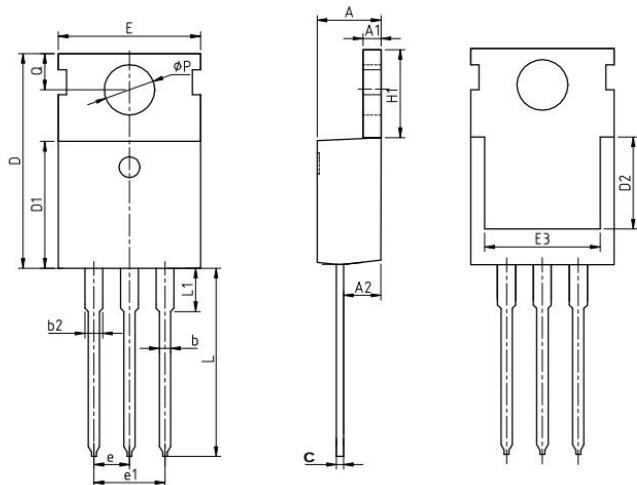


## Gate Charge Test Circuit



## Package Information

### TO-220AB

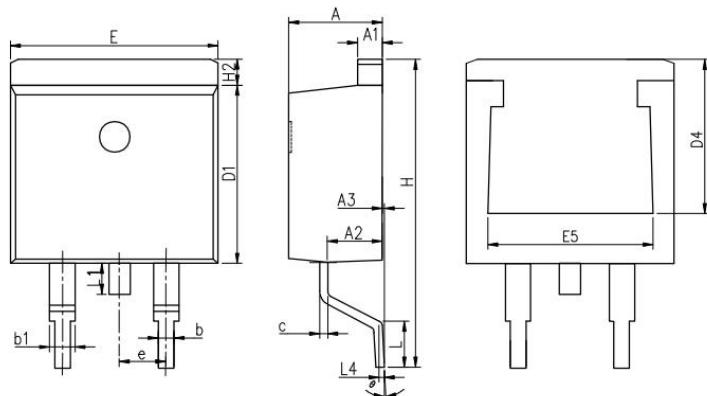


COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	4.37	4.57	4.77
A1	1.25	1.30	1.45
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
c	0.40	0.50	0.65
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	-
e	2.54 BSC		
e1	5.08 BSC		
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
ΦP	3.40	3.60	3.80
Q	2.60	2.80	3.00

## Package Information

### TO-263



COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	4.37	4.57	4.77
A1	1.22	1.27	1.42
A2	2.49	2.69	2.89
A3	0	0.13	0.25
b	0.7	0.81	0.96
b1	1.17	1.27	1.47
c	0.3	0.38	0.53
D1	8.5	8.7	8.9
D4	6.6	-	-
E	9.86	10.16	10.36
E5	7.06	-	-
e	2.54 BSC		
H	14.7	15.1	15.5
H2	1.07	1.27	1.47
L	2	2.3	2.6
L1	1.4	1.55	1.7
L4	0.25 BSC		
θ	0°	5°	9°